INTEGRATED CIRCUITS



Product data Supersedes data of 2001 Feb 13 2002 Dec 13



PHILIP

CBTS3384

FEATURES

- 5 Ω switch connection between two ports
- TTL compatible control input and output levels
- Undershoot protection included to prevent shoot through level changes
- Latch-up protection exceeds 500 mA per JESD78
- ESD protection exceeds 2000 V HBM per JESD22-A114, 200 V MM per JESD22-A115 and 1000 V CDM per JESD22-C101

DESCRIPTION

The CBTS3384 provides ten bits of high-speed TTL-compatible bus switching. The low on-state resistance of the switch allows connections to be made with minimal propagation delay.

The CBTS3384 device is organized as two 5-bit bus switches with separate output-enable (\overline{OE}) inputs. When \overline{OE} is LOW, the switch is on and port A is connected to B. When \overline{OE} is HIGH, the switch is open and high-impedance state exists between the two ports.

The CBTS3384 is characterized for operation from -40 to +85 °C.

PIN CONFIGURATION



PIN DESCRIPTION

PIN NUMBER	SYMBOL	NAME AND FUNCTION
1, 13	10E, 20E	Output enables
3, 4, 7, 8, 11	1A1-1A5	Inputs
14, 17, 18, 21, 22	2A1-2A5	Inputs
2, 5, 6, 9, 10	1B1-1B5	Outputs
15, 16, 19, 20, 23	2B1-2B5	Outputs
12	GND	Ground (0 V)
24	V _{CC}	Positive supply voltage

QUICK REFERENCE DATA

SYMBOL	PARAMETER	CONDITIONS T _{amb} = 25 °C; GND = 0 V	TYPICAL	UNIT
t _{PLH} t _{PHL}	Propagation delay An to Yn	C _L = 50 pF; V _{CC} = 5 V	250	ps
C _{IN}	Input capacitance	$V_I = 0 V \text{ or } V_{CC}$	4	pF
C _{OUT}	Output capacitance	Outputs disabled; $V_0 = 0 V$ or V_{CC}	10	pF
I _{CCZ}	Total supply current	Outputs disabled; V_{CC} = 5.5 V	3	μΑ

ORDERING INFORMATION

PACKAGES	TEMPERATURE RANGE	ORDER CODE	DWG NUMBER
24-Pin Plastic SO	-40 to +85 °C	CBTS3384D	SOT137-1
24-Pin Plastic SSOP	-40 to +85 °C	CBTS3384DB	SOT340-1
24-Pin Plastic SSOP (QSOP)	-40 to +85 °C	CBTS3384DK	SOT556-1
24-Pin Plastic TSSOP	-40 to +85 °C	CBTS3384PW	SOT355-1

Standard packing quantities and other packaging data is available at www.philipslogic.com/packaging.

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LOGIC SYMBOL



FUNCTION TABLE

INP	JTS	OUTF	PUTS
1 <mark>0E</mark>	2 <mark>0E</mark>	1A, 1B	2A, 2B
L	L	1A = 1B	2A= 2B
L	Н	1A = 1B	Z
н	L	Z	2A = 2B
н	Н	Z	Z

H = High voltage level

L = Low voltage level

Z = High impedance "off" state

ABSOLUTE MAXIMUM RATINGS^{1, 2}

SYMBOL	PARAMETER	CONDITIONS	RATING	UNIT
V _{CC}	DC supply voltage		-0.5 to +7.0	V
I _{IK}	DC input diode current		-50	mA
VI	DC input voltage ³		-1.2 to +7.0	V
I _{SW}	DC output diode current	V _O < 0	±128	mA
T _{stg}	Storage temperature range		-65 to +150	°C

NOTES:

1. Stresses beyond those listed may cause permanent damage to the device. These are stress ratings only and functional operation of the device at these or any other conditions beyond those indicated under "recommended operating conditions" is not implied. Exposure to absolute-maximum-rated conditions for extended periods may affect device reliability.

2. The performance capability of a high-performance integrated circuit in conjunction with its thermal environment can create junction temperatures which are detrimental to reliability. The maximum junction temperature of this integrated circuit should not exceed 150°C.

3. The input and output voltage ratings may be exceeded if the input and output current ratings are observed.

RECOMMENDED OPERATING CONDITIONS

SYMBOL	PARAMETER	LIM	UNIT	
	PARAMETER	Min	Max	UNIT
V _{CC}	DC supply voltage	4.5	5.5	V
V _{IH}	High-level input voltage	2.0		V
V _{IL}	Low-level Input voltage		0.8	V
T _{amb}	Operating free-air temperature range	-40	+85	°C

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DC ELECTRICAL CHARACTERISTICS

				UNIT		
SYMBOL	PARAMETER	TEST CONDITIONS	T _{amb} = -40 to +85 °C			
				Typ ¹	Max	
V _{IK}	Input clamp voltage	V _{CC} = 4.5 V; I _I = -18 mA		—	-1.2	V
Ц	Input leakage current	V_{CC} = 5.5 V; V_{I} = GND or 5.5 V		—	±1	μΑ
I _{CC}	Quiescent supply current ²	V_{CC} = 5.5 V; I_O = 0, V_I = V_{CC} or GND		—	3	μΑ
ΔI_{CC}	Additional supply current per input pin ²	V_{CC} = 5.5 V, one input at 3.4 V, other inputs at V_{CC} or GND	_	-	2.5	mA
CI	Control pins	V _I = 3.0 V or 0		4	—	pF
C _{I(OFF)}	Power-off leakage current	$V_{O} = 3.0 \text{ V or } 0, \overline{OE} = V_{CC}$		10	—	pF
		$V_{CC} = 4.5 \text{ V}; \text{ V}_{I} = 0 \text{ V}; \text{ I}_{I} = 64 \text{ mA}$		5	7	
r _{on} ³	On-resistance	$V_{CC} = 4.5 \text{ V}; \text{ V}_{I} = 0 \text{ V}; \text{ I}_{I} = 30 \text{ mA}$		5	7	Ω
		$V_{CC} = 4.5 \text{ V}; \text{ V}_{I} = 2.4 \text{ V}; \text{ I}_{I} = -15 \text{ mA}$		10	15	
VP	Pass voltage	V_{I} = V_{CC} = 5.0 V; I_{O} = -100 μ A	3.4	3.6	3.9	V
I _{UCP}	Undershoot static current protection	V_{CC} = 5.0 V, I_B = 400 $\mu A;$ \overline{OE} = 5.0 V; $V_B \ge 3.0$ V	_	8	_	mA

NOTES:

1. All typical values are at $V_{CC} = 5 \text{ V}$, $T_{amb} = 25 \text{ °C}$. 2. This is the increase in supply current for each input that is at the specified TTL voltage level rather than V_{CC} or GND. 3. Measured by the voltage drop between the A and the B terminals at the indicated current through the switch. On-state resistance is determined by the lowest voltage of the two (A or B) terminals.

AC CHARACTERISTICS

 $GND = 0 V; t_{R}; C_{L} = 50 pF$

	PARAMETER			LIMITS			
SYMBOL		FROM (INPUT)	TO (OUTPUT)	V _{CC} = +5.0	UNIT		
			(001101)	Min	Max		
t _{pd}	Propagation delay ¹	A or B	B or A	—	0.25	ns	
t _{en}	Output enable time to High and Low level	ŌĒ	A or B	1.0	5.7	ns	
t _{dis}	Output disable time from High and Low level	ŌĒ	A or B	1.0	5.2	ns	

NOTE:

1. This parameter is warranted but not production tested. The propagation delay is based on the RC time constant of the typical on-state resistance of the switch and a load capacitance of 50 pF, when driven by an ideal voltage source (zero output impedance).

			LIMITS			
			-40 to +85° C			
SYMBOL	PARAMETER DESCRIPTION		V _{CC} = 5 V, ±0.5 V			
		MIN.	MEAN	MAX.		
t _{PD}	Propagation delay (see Note 1)	—	—	250	pS	
t _{PZH}	Output enable time to High level	1.6	3.4	5.6	nS	
t _{PHZ}	Output enable time from High level	1.7	3.3	5.5	nS	
t _{PZL}	Output enable time to Low level	2.3	4	6	nS	
t _{PLZ}	Output enable time from Low level	2.5	4.5	6.6	nS	

NOTE:

1. This parameter is warranted but not production tested. The propagation delay is based on the RC time constant of the typical on-state resistance of the switch and a load capacitance of 50 pF, when driven by an ideal voltage source (zero output impedance); at +25 °C.

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AC WAVEFORMS



Waveform 1. Input (An) to Output (Yn) Propagation Delays



Waveform 2. 3-State Output Enable and Disable Times

TEST CIRCUIT AND WAVEFORMS



NOTES:

- 1. All input pulses are supplied by generators having the following characteristics: PRR \leq 10 MHz, Z_O = 50 Ω , t_r \leq 2.5 ns, t_f \leq 2.5 ns.
- The outputs are measured one at a time with one transition per measurement.

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Product data



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Product data



SSOP24: plastic shrink small outline package; 24 leads; body width 3.9 mm; lead pitch 0.635 mm



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REVISION HISTORY

Rev	Date	Description
_2	20021213	Product data (9397 750 09249); ECN 853-2238 27501 of 20 December 2001.
		Modifications:
		 New package release.
_1	20010213	Product data (9397 750 08073); ECN 853-2238 25635 of 13 February 2001.

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Data sheet status

Level	Data sheet status ^[1]	Product status ^{[2] [3]}	Definitions
I	Objective data	Development	This data sheet contains data from the objective specification for product development. Philips Semiconductors reserves the right to change the specification in any manner without notice.
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[3] For data sheets describing multiple type numbers, the highest-level product status determines the data sheet status.

Definitions

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Limiting values definition — Limiting values given are in accordance with the Absolute Maximum Rating System (IEC 60134). Stress above one or more of the limiting values may cause permanent damage to the device. These are stress ratings only and operation of the device at these or at any other conditions above those given in the Characteristics sections of the specification is not implied. Exposure to limiting values for extended periods may affect device reliability.

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Contact information

For additional information please visit http://www.semiconductors.philips.com. Fax: +31 40 27 24825

sales.addresses@www.semiconductors.philips.com.

For sales offices addresses send e-mail to:

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